

Technical Data
Data Sheet 4856, Rev.-

MURC520
Ultrafast Silicon Die

Applications:

- Switching Power Supply
- General Purpose
- Free-Wheeling Diodes
- Polarity Protection Diode

Features:

- Glass-Passivated
- Epitaxial Construction.
- Low Reverse Leakage Current
- High Surge Current Capability
- Low Forward Voltage Drop
- Fast Reverse-Recovery Behavior

Maximum Ratings:

Characteristics	Symbol	Condition	Max.	Units
Peak Inverse Voltage	V_{RWM}	-	200	V
Max. Average Forward	$I_{F(AV)}$	50% duty cycle @ $T_C = 105^\circ C$, rectangular wave form	5.0	A
Max. Peak One Cycle Non-Repetitive Surge Current	I_{FSM}	8.3 ms, half Sine pulse	65	A
Max. Junction Temperature	T_J	-	-40 to +150	°C
Max. Storage Temperature	T_{stg}	-	-40 to +150	°C

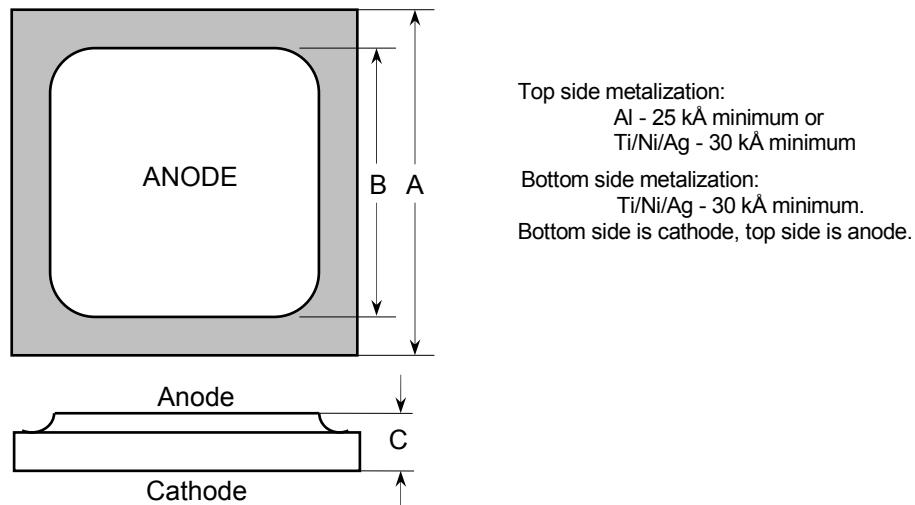
Electrical Characteristics:

Characteristics	Symbol	Condition	Max.	Units
Max. Forward Voltage Drop *	V_{F1}	@ 5.0A, Pulse, $T_J = 25^\circ C$	0.98	V
Max. Reverse Current *	I_{R1}	@ $V_R = \text{rated } V_R$ $T_J = 25^\circ C$	0.25	mA
	I_{R2}	@ $V_R = V_R$ $T_J = 100^\circ C$	1.0	mA
Max. Junction Capacitance	C_T	@ $V_R = 5V$, $T_C = 25^\circ C$ $f_{SIG} = 1MHz$, $V_{SIG} = 50mV$ (p-p)	75	pF
Max Reverse Recovery Time	t_{rr}	$I_F = 1.0A$, $dI/dt = 50A/\mu s$ $I_F = 0.5A$, $I_R = 1.0A$, $I_{REC} = 0.25A$	35 25	nS

* Pulse Width < 300μs, Duty Cycle <2%

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Dimensions in inches (mm)



Die type	Area (mil ²)	Dimension A ⁽¹⁾ Inch (millimeter)	Dimension B ⁽¹⁾ Inch (millimeter)	Dimension C ⁽²⁾ Inch (millimeter)
Si p-n die	85 x 85	0.085 (2.159)	0.069 (1.753)	0.009 (0.229)

⁽¹⁾ Tolerance is ± 0.003 " (0.076 mm)

⁽²⁾ Tolerance is ± 0.001 " (0.025 mm)

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